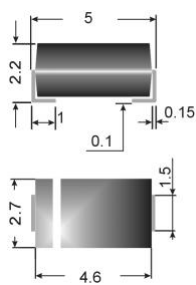


# S2 SMA A ... S2 SMA M



## Surface mount diode

## Standard silicon rectifier diodes

### S2 SMA A ... S2 SMA M

Forward Current: 2 A

Reverse Voltage: 50 to 1000 V

### Features

- Max. solder temperature: 260°C
- Plastic material has UL classification 94V-0

### Mechanical Data

- Plastic case: SMA / DO-214AC
- Weight approx.: 0,07 g
- Terminals: plated terminals solderable per MIL-STD-750
- Mounting position: any
- Standard packaging: 7500 pieces per reel

1) Max. temperature of the terminals  $T_T = 80^\circ\text{C}$

2)  $I_F = 2\text{ A}$ ,  $T_J = 25^\circ\text{C}$

3)  $T_A = 25^\circ\text{C}$

4) Mounted on P.C. board with 25 mm<sup>2</sup> copper pads at each terminal

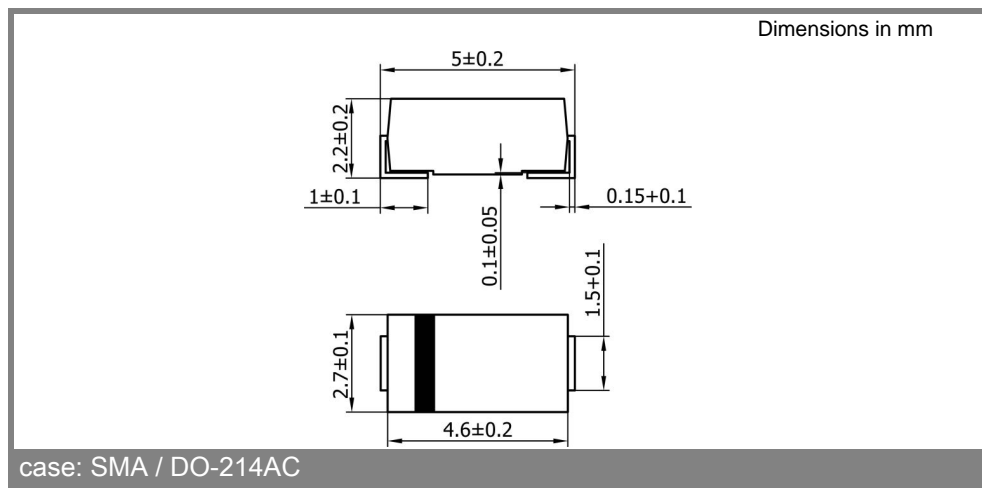
Type	Polarity color band	Repetitive peak reverse voltage $V_{RRM}$ V	Surge peak reverse voltage $V_{RSM}$ V	Maximum forward voltage $T_j = 25^\circ\text{C}$ $I_F = 2\text{ A}$ $V_F^{(2)}$ V	Maximum reverse recovery time $I_F = -\text{A}$ $I_R = -\text{A}$ $I_{RR} = -\text{A}$ $t_{rr}$ ns
S2 SMA A	-	50	50	1,15	-
S2 SMA B	-	100	100	1,15	-
S2 SMA D	-	200	200	1,15	-
S2 SMA G	-	400	400	1,15	-
S2 SMA J	-	600	600	1,15	-
S2 SMA K	-	800	800	1,15	-
S2 SMA M	-	1000	1000	1,15	-

### Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ , unless otherwise specified

Symbol	Conditions	Values	Units
$I_{FAV}$	Max. averaged fwd. current, R-load, $T_T = 80^\circ\text{C}$ 1)	2	A
$I_{FRM}$	Repetitive peak forward current $f > 15\text{ Hz}$ 1)	10	A
$I_{FSM}$	Peak fwd. surge current 50 Hz half sinus-wave 3)	50	A
$I^2t$	Rating for fusing, $t < 10\text{ ms}$ 3)	12,5	A <sup>2</sup> s
$R_{thA}$	Max. thermal resistance junction to ambient 4)	70	K/W
$R_{thT}$	Max. thermal resistance junction to terminals	30	K/W
$T_j$	Operating junction temperature	- 50 ... + 150	°C
$T_s$	Storage temperature	- 50 ... + 150	°C

### Characteristics $T_A = 25^\circ\text{C}$ , unless otherwise specified

Symbol	Conditions	Values	Units
$I_R$	Maximum leakage current, $T_j = 25^\circ\text{C}$ ; $V_R = V_{RRM}$	<5	µA
	$T_j = 100^\circ\text{C}$ ; $V_R = V_{RRM}$	<100	µA
$C_j$	Typical junction capacitance (at MHz and applied reverse voltage of V)	-	pF
$Q_{rr}$	Reverse recovery charge ( $U_R = V$ ; $I_F = A$ ; $dI_F/dt = A/ms$ )	-	µC
$E_{RSM}$	Non repetitive peak reverse avalanche energy (L = mH; $T_j = ^\circ\text{C}$ ; inductive load switched off)	-	mJ



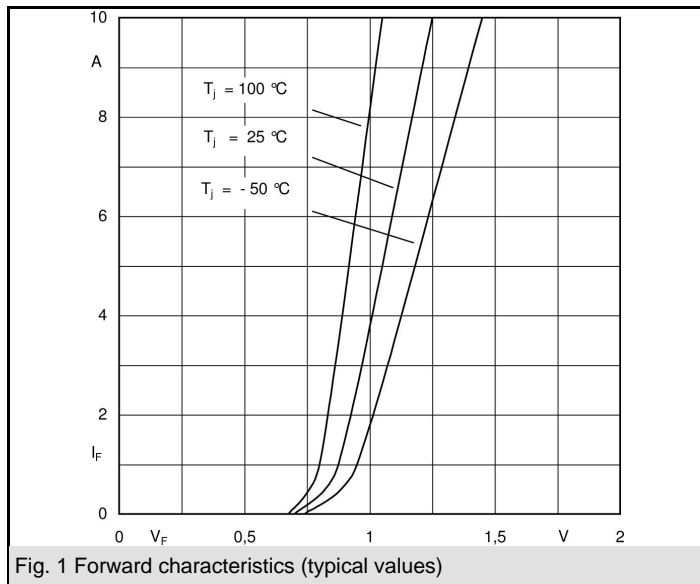


Fig. 1 Forward characteristics (typical values)

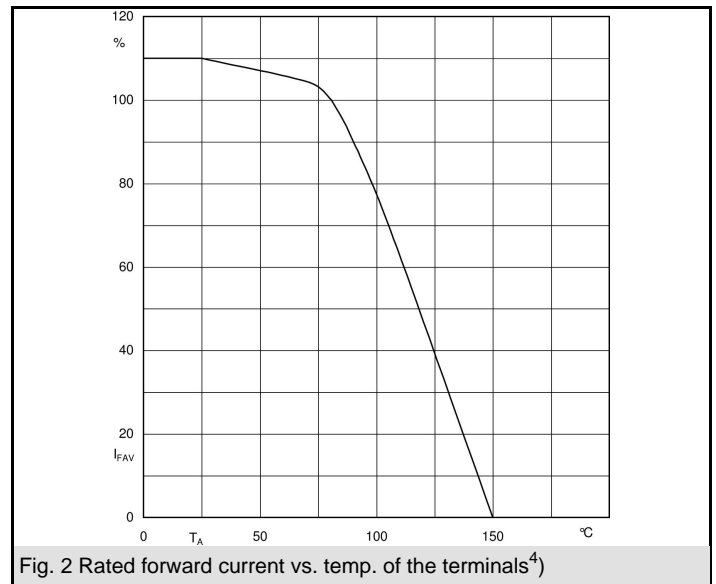


Fig. 2 Rated forward current vs. temp. of the terminals<sup>4)</sup>